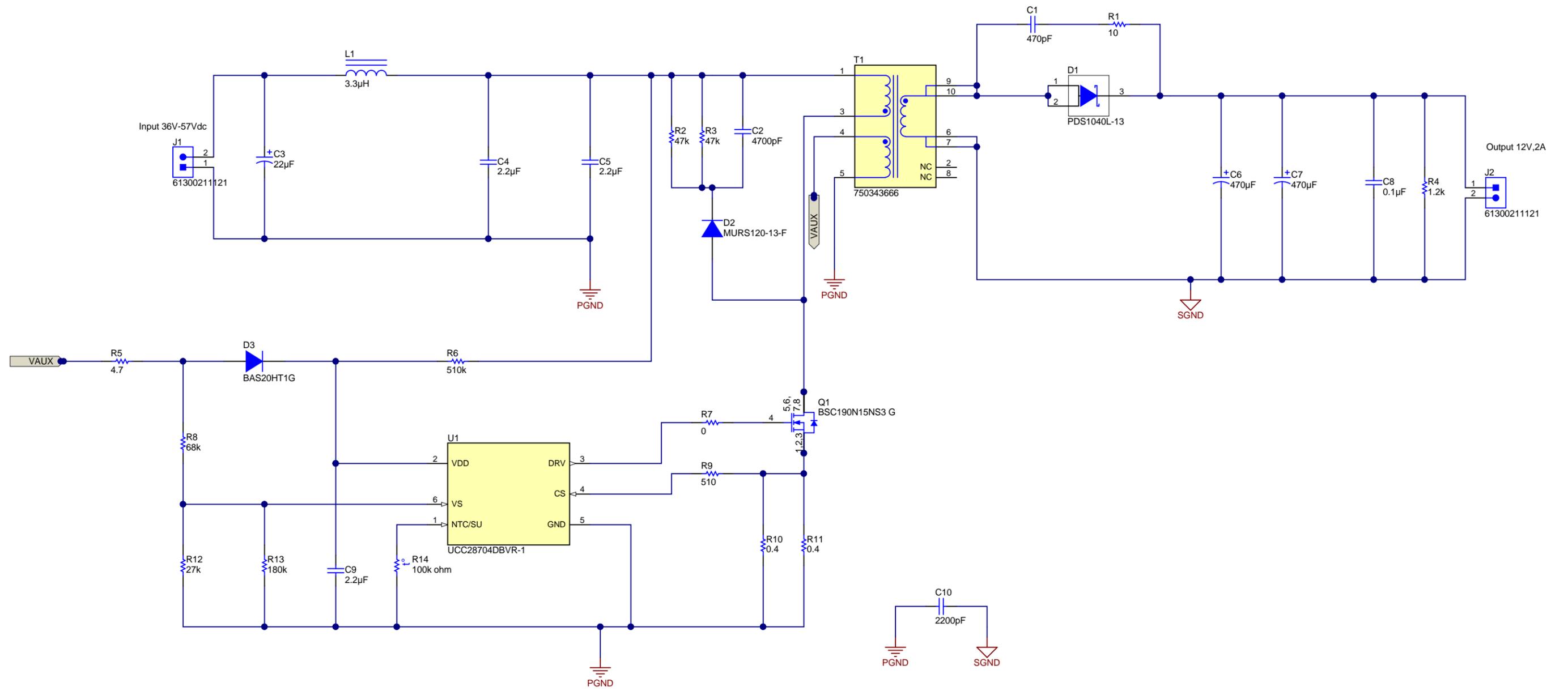


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: N/A	Project Title: 36V-57VIN, 12V2A PSR Solution for PoE Reference		
Number: <a href="#">PMP40144</a>	Rev: <a href="#">E1</a>	Sheet Title:	
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: 001	Sheet: 1 of 1	
Drawn By: <a href="#">David Ji</a>	File: <a href="#">PMP40144_CoverSheet.SchDoc</a>	Size: B	
Engineer: <a href="#">David Ji</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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